

Electronic supplementary information

Carbon-nanotube bridge fabricated by laser comb

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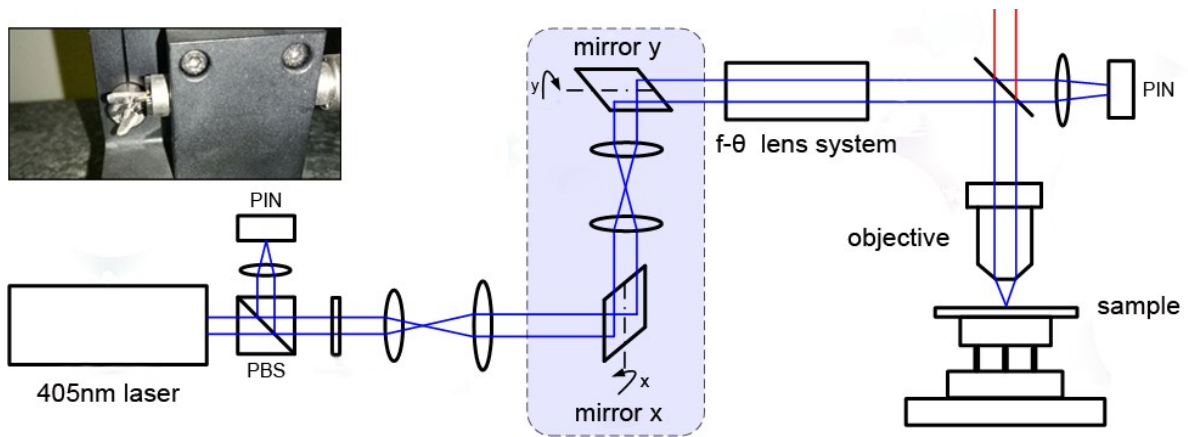


Fig. S1 Main optical system to carry out the Laco method. The inset at the top left is the real photo of two vibrating mirrors (X and Y).

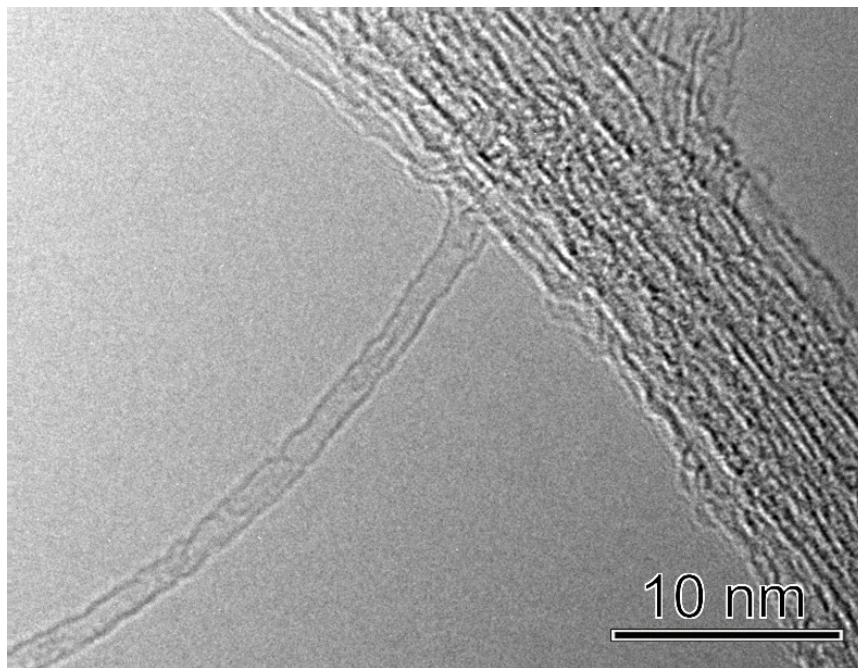


Fig. S2 TEM image of the single-walled carbon nanotubes (SWNTs) grown by chemical vapor deposition (CVD)

As shown in the left of Fig. S2, a individual carbon nanotube displays a typical single-walled feature and the diameter of this individual nanotube is about 1.5 nm. As shown in the right of Fig. S2, individual SWNTs can also aggregate into bundles.

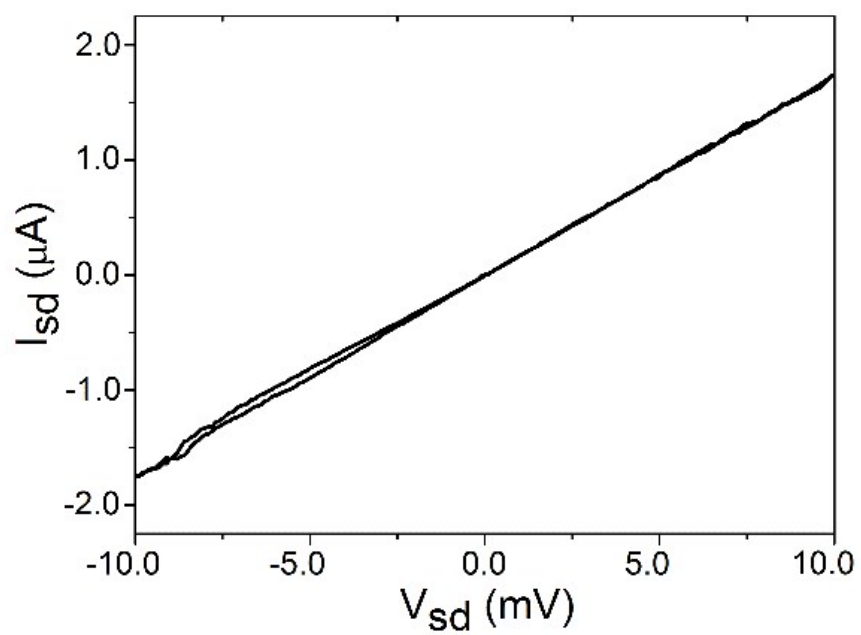


Fig. S3 Typical two-terminal current-voltage characteristic of the connected CNTs network.

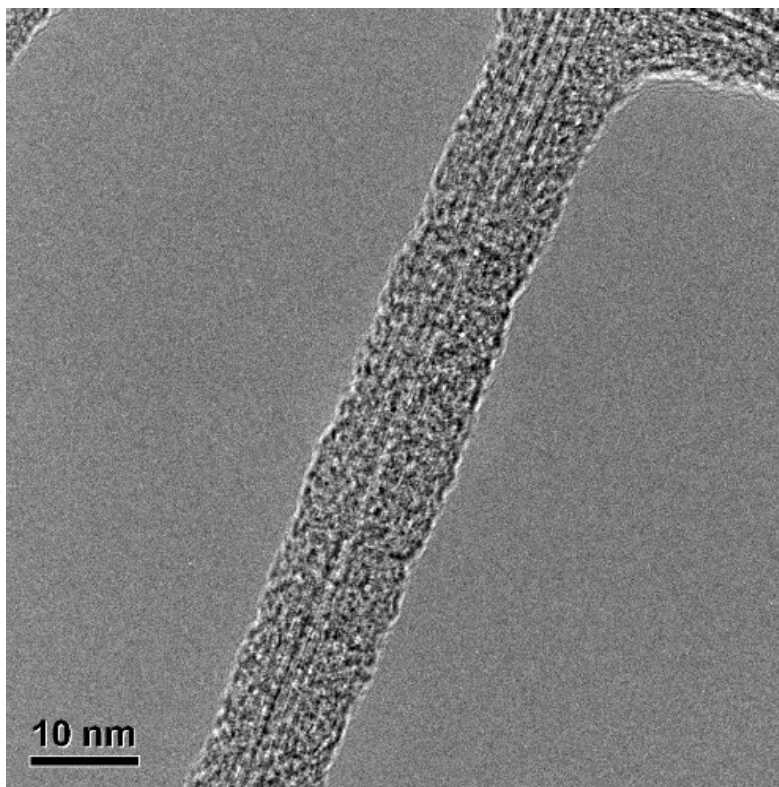


Fig. S4 TEM image of the single-walled carbon nanotubes (SWNTs) after laser direct writing

Table S1. Material properties used in the numerical simulation.

Material properties	Value
Density of carbon nanotube ($\text{kg}\cdot\text{m}^{-3}$)	1350 ¹
Density of SiO_2 ($\text{kg}\cdot\text{m}^{-3}$)	2200 ²
Density of Si ($\text{kg}\cdot\text{m}^{-3}$)	2330 ³
Thermal conductivity of carbon nanotube ($\text{W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$)	3500 ⁴
Thermal conductivity of SiO_2 ($\text{W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$)	1.4 ²
Thermal conductivity of Si ($\text{W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$)	148 ⁵
Specific heat of carbon nanotube ($\text{J}\cdot\text{kg}^{-1}\cdot\text{K}^{-1}$)	78.3 ¹
Specific heat of SiO_2 ($\text{J}\cdot\text{kg}^{-1}\cdot\text{K}^{-1}$)	937 ²
Specific heat of Si ($\text{J}\cdot\text{kg}^{-1}\cdot\text{K}^{-1}$)	705 ⁵

REFERENCES

1. T. Nakamiya, T. Ueda, T. Ikegami, K. Ebihara and R. Tsuda, *Current Applied Physics*, 2008, **8**, 400-403.
2. N. Dong and L. Kondic, *Physical Review Fluids*, 2016, **1**.
3. Z. Li, H. Zhang, Z. Shen and X. Ni, *Journal of Applied Physics*, 2013, **114**.
4. E. Pop, D. Mann, Q. Wang, K. E. Goodson and H. J. Dai, *Nano Letters*, 2006, **6**, 96-100.
5. T.-Y. Yang, I.-M. Park, H.-Y. You, S.-H. Oh, K.-W. Yi and Y.-C. Joo, *Journal of the Electrochemical Society*, 2009, **156**, H617-H620.